# High Power PIN Diode 50 MHz - 12 GHz

Rev. V3

### Electrical Specifications: $T_A = +25$ °C

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Forward Voltage	+50 mA D.C.	V	0.7	0.9	1.1
Reverse Leakage Current	-200 V D.C.	nA	_	- 20	-1000
Total Capacitance <sup>5</sup>	-50 V @ 1 MHz	pF	_	0.24	0.30
Series Resistance <sup>6</sup>	+10 mA @ 1 GHz	Ω	_	3.4	4.4
Parallel Resistance <sup>6</sup>	-Vdc = -40 V, @ 100 MHz	ΚΩ	_	500	_
Minority Carrier Lifetime	+If = 10 mA / -Ir = -6 mA (50% Control Voltage, 90% Output Voltage)	μs	_	2.0	3.0
C.W. Thermal Resistance ( Infinite Heat Sink at Thermal Ground Plane)	I High = 4 A, I low = 10 mA @ 10 kHz	°C/W	_	35	_
Power Dissipation <sup>7,8</sup> (Infinite Heat Sink at Thermal Ground Plane)	+If = 50 mA @ 1 GHz	W	_	4.3	_
Insertion Loss	F = 1 GHz, -Vdc = -10 V	dB		0.05	
Isolation	F = 1 GHz, +I bias = +10 mA	dB	16.5	18.5	

- 5. Ct (Total Capacitance) = CJ (Junction Capacitance) + Cp (Parasitic Package Capacitance).
- 6. Rs and Rp are measured on an HP4291A Impedance Analyzer.
- 7. De-rate power dissipation linearly by -28.6 mW/°C to 0 W @ +175°C: Pd (T) = Pd (+ 25°C) ΔP = Pd (+ 25°) (28.6 mV/°C) (ΔT).
- 8. PD = ΔTj / Θ or PD=(IF + IRF) 2 (Rs), where IF is the forward bias DC current and IRF is the forward bias RMS RF current.

# **Absolute Maximum Ratings**<sup>9,10</sup>

Parameter	Absolute Maximum	
D.C. Forward Voltage @ +250 mA	1.2 V	
D.C. Forward Current	250 mA	
D.C. Reverse Voltage	-200V	
Junction Temperature	+175°C	
Operating Temperature	-65°C to +125°C	
Storage Temperature	-65°C to +150°C	
Re-flow Temperature	+260°C for 360 seconds	

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- 10. M/A-COM Technology Solutions does not recommend sustained operation near these survivability limits.

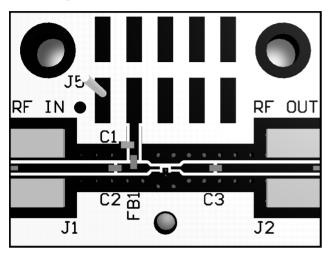
### **Handling Procedures**

Please observe the following precautions to avoid damage:

#### **Static Sensitivity**

These devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these Class 1B devices.

### **PCB Layout**

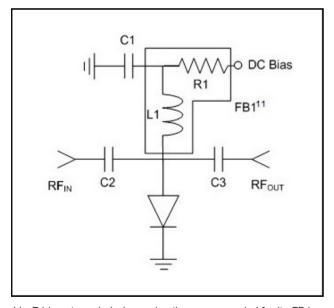


#### 500 - 5000 MHz Parts List12

Part	Value	Case Style
C1	62 pF	0402
C2, C3	100 pF	0402
FB1	470 Ω @ 1 GHz	0402
R1	150 Ω	0402
L1	82 nH	0402

12. Max DC voltage with recommended components not to exceed 100 V.

#### **PCB Schematic**



11. R1 is not needed when using the recommended ferrite FB1.

### **Assembly Recommendations**

Devices may be soldered using standard Pb60/Sn40, or RoHS compliant solders. Leads are plated NiPdAuAg to ensure an optimum solderable connection.

For recommended Sn/Pb and RoHS soldering profile See Application Note M538 on the MACOM website.

#### **Cleanliness and Storage**

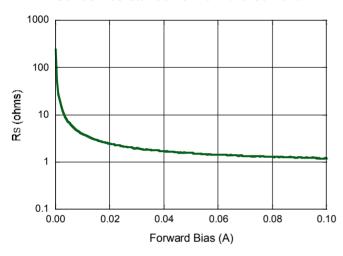
These devices should be handled and stored in a clean environment. Ends of the device are NiPdAuAg plated for greater solderability. Exposure to high humidity (>80%) for extended periods may cause the surface to oxidize. Caution should be taken when storing devices for long periods.

#### **General Handling**

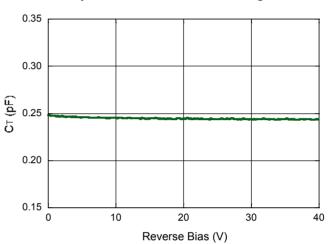
Device can be handled with tweezers or vacuum pickups and are suitable for use with automatic pick-and-place equipment.

## **Typical 1 GHz Parametric Curves**

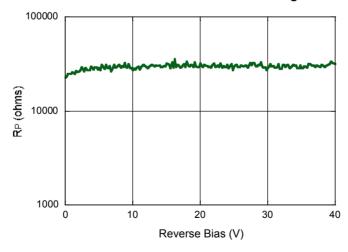
#### Series Resistance vs. Forward Current



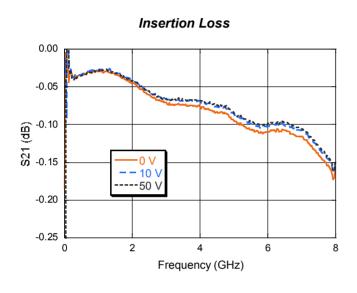
#### Capacitance vs. Reverse Voltage

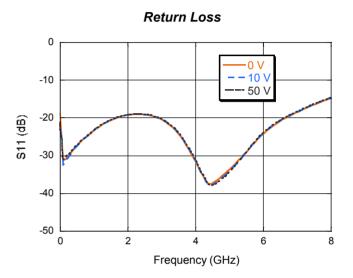


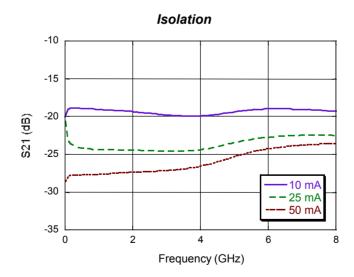
#### Parallel Resistance vs. Reverse Voltage



# **Typical RF Small Signal Performance Curves**



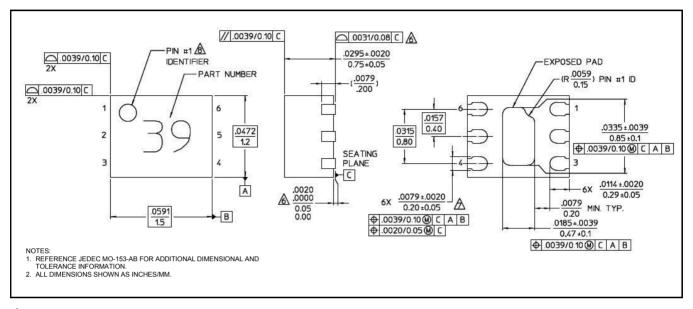




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### Lead-Free 1.5 x 1.2 mm 6-Lead TDFN<sup>†</sup>



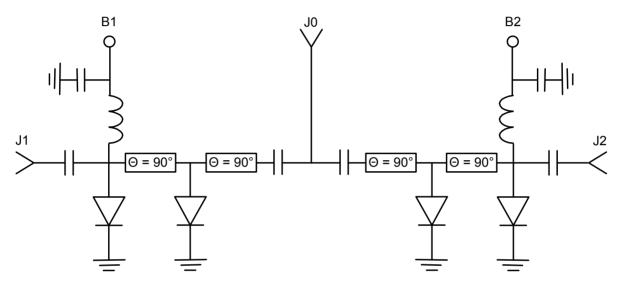
<sup>&</sup>lt;sup>†</sup> Reference Application Note <u>S2083</u> for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is NiPdAuAg.

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# **Applications Section**

Schematic of High Power SP2T Shunt Switch using MADP-011028-14150T PIN Diodes F = Octave Bandwidth from 1 to 12 GHz  $P_{inc}$  = +40 dBm CW  $P_{inc}$  = +50 dBm, 10  $\mu$ s PW, 1 % Duty



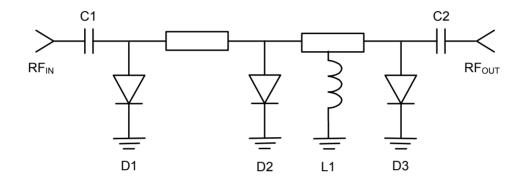
L = 11.807 / ( $\epsilon$ eff  $^{1/2}$  \* F \* 4) inches,  $\theta$  =  $\beta$  \* L = ( $2\pi/\lambda$ ) \* L = 90 °

Frequency is in GHz, Eeff is Effective Dielectric Constant of Transmission Line Medium

RF State	B1 Bias	B2 Bias	
J0-J1 Low Loss & J0-J2 Isolation	-50 V @ 0 mA	+1 V @ +20 mA	
J0-J2 Low Loss & J0-J1 Isolation	+1 V @ +20 mA	-50 V @ 0 mA	

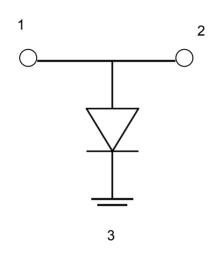
# **Applications Section**

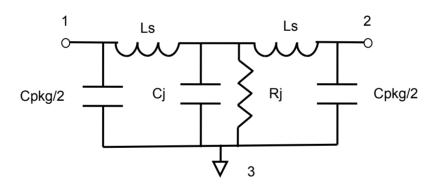
Schematic of 3 Stage Limiter using MADP-011028-14150T F = 1000 - 8,000 MHz  $P_{inc} = +47 \text{ dBm CW}$   $P_{inc} = +50 \text{ dBm}, 10 \text{ } \mu\text{s P.W.}, 1 \text{ } \% \text{ Duty}$ 



Part	PN	Case Style	Description	Quantity
D1	MADP-011028-14150T	ODS-1415	Input PIN Diode	1
D2	MADL-011023-14150T	ODS-1415	2nd Stage PIN Diode	1
D3	MADL-011023-14150T	ODS-1415	3rd Stage PIN Diode	1
L1	33 nH	0402	RF Choke / DC Return	1
C1	27 pF	0402	DC Block	1
C2	27 pF	0402	DC Block	1

#### Microwave Model of MADP-011028-14150T





Rj = Rs ( Forward Bias Current ) Rj = Rp ( Reverse Bias Voltage )

Parameter	Value	
$C_{package}$	8.0E-14 F	
L bond = Ls	4.0E-10 H	
Rs	0.9 Ω	
Rp	5E+5 Ω	

# MADP-011028-14150T

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